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PART NO. SEE TABLE 1

REVISIONS

LTR	DESCRIPTION	Drawing	DATE
C	修改圖面與實物相符	GARY	02/28/07
D	新增端子折彎剖視圖	GARY	05/23/07
E	修改塑膠壁厚	GARY	09/21/07

**CUSTOMER
DRAWING**

TABLE 1

020-01-00271	15 U"	PA BLACK	3.0	ADD LATCH
020-01-00272	G/F	PA BLACK	3.0	ADD LATCH
020-01-00273	15 U"	PA BLACK	2.6	NO LATCH
020-01-00274	G/F	PA BLACK	2.6	NO LATCH
020-01-00275	15 U"	PA BLACK	4.3	ADD LATCH
020-01-00276	G/F	PA BLACK	4.3	ADD LATCH
020-01-00277	15 U"	LCP BLACK	4.3	ADD LATCH
020-01-00278	G/F	LCP BLACK	4.3	ADD LATCH
PART NO.	PLATED	COLOR FOR THE PLASTIC	DIM A	NOTE

SECTION
A-A

SECTION
B-B

RECOMMENDED PCB LAYOUT

NOTE:

- MATERIAL :
HOUSING : High Temperature Thermoplastic ,
UL94V-0, COLOR : BLACK
TERMINAL(max): Copper Alloy, THICKNESS = 0.30 mm
TERMINAL(min): Copper Alloy, THICKNESS = 0.25 mm
FORKLOCK: Copper Alloy, THICKNESS = 0.30 mm
- PLATING:
CONTACT: GOLD OVER 50u" MIN NICKEL UNDERPLATE (SEE TABLE 1)
SOLDER TAIL: 150u" MIN MISTY TIN 50u" MIN NICKEL UNDERPLATE
GOLD SPECIFICATION: SEE TABLE
- ELECTRONICAL SPECIFICATION:
CURRENT RATING: 1.5 AMPERE PER CONTACT
CONTACT RESISTANCE: 30 MILLIOHMS MAX.
INSULATION RESISTANCE: 1000 MEGOHMS MIN.
DIELECTRIC WITHSTANDING VOLTAGE: 500 VDC.
OPERATING TEMPERATURE: -20°C ~ +85°C
- MEETS THE REQUIREMENTS OF DIRECTIVE 2002/95/EC OF THE EUROPEAN PARLIAMENT AND OF THE COUNCIL OF 27 JANUARY 2003 ON THE RESTRICTION OF THE USE OF CERTAIN HAZARDOUS SUBSTANCES IN ELECTRICAL AND ELECTRONIC EQUIPMENT (ROHS)

DIMENSION ARE MILLIMETERS TOLERANCES ARE : DECIMALS .X ± 0.20 .XX ± 0.15 ANGLE: X ± 3°	APPROVALS		DATE	PART NO. 020-01-00271/00272 020-01-00273/00274 020-01-00275/00276 020-01-00277/00278
	DRAWN	GARY	09/21/07	
	CHECKED			
	APPROVALS			TITLE: SAS 29P Vertical DIP WITHOUT BULGE(4 ROW)
SIZE	SCALE :	DRAWING NO.	REV.	
mm	1 : 1	000452	E	
ID NO.	XXXXXXXXXX	SHEET 1 OF 1		

DESCRIPTION

QTY

UNIT

DO NOT SCALE DRAWING

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